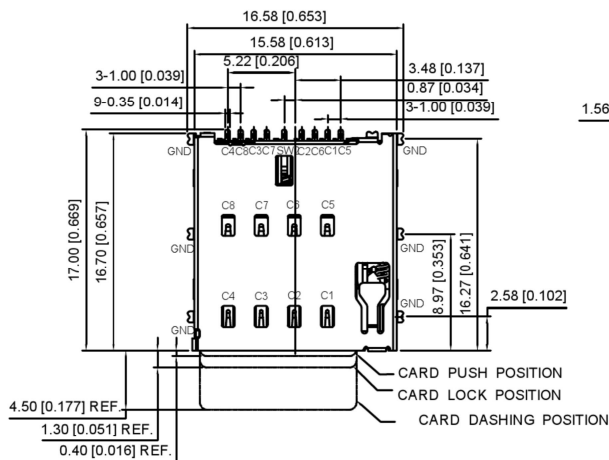


NOTES:

1. MATERIAL:

- 1.1 Housing:High Temperature Thermoplastic UL94V-0; Color Black.
- 1.2 Terminal:Copper Alloy.
- 1.3 Shell:Stainless Steel.

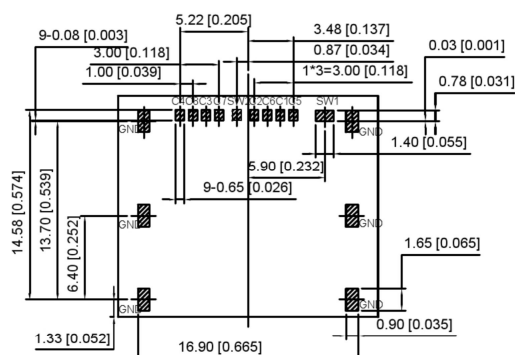
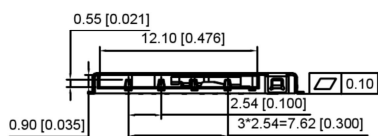
2. SPECIALITY:

- 2.1 Rated current:1.0A
- 2.2 Rated voltage:50V
- 2.3 Contact Resistance:100m Ω MAX
- 2.4 Insulation Resistance:1000M Ω MIN 500V DC
- 2.5 Dielectric withstanding voltage: 500V AC.
- 2.6 Solder ability:255±5 °C, 5±0.5s.
- 2.7 Durability:5000 Cycles Min.
- 2.8 Operating condition:Temperature-40 °C ~ +85 °C; Humidity 80% R.H MAX

3. PLEASE CONTACT JITS SALES REPRESENTATIVE TO VERIFY PRODUCT DETAILS & AVAILABILITY

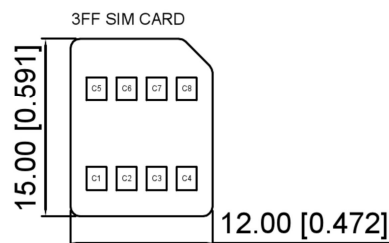
DETECT SWITCH

CARD INSERTING POSITION	CLOSE	CLOSE SW1 SW2
NO CARD	OPEN	OPEN SW1 SW2



RECOMMENDED P.C.B LAYOUT
TOP VIEW(TOLERANCE±0.05)

Card is not inserted;
Sw2 and Sw1/GND pin is open
Card is inserted;
Sw2 and Sw1/GND pin is close



ITEM	PART NAME	Q'TY	MATERIAL	FINISHING
1	HOUSING	1	LCP	Black UL94V-0
2	TERMINAL	9	COPPER ALLOY	Contact area : Gold plated
3	SHELL	1	SUS	SMT area : Gold plated
4	LINK	1	SUS304	
5	SPRING	1	SWP	
6	SLIDER	1	LCP	Black UL94V-0

				ANGLAR	±5°
				L ≤ 4	±0.2
				4 < L ≤ 16	±0.3
				16 < L ≤ 63	±0.4
	DATE	REVISED	APPROVED	L > 63	±0.5
REVISIONS				UNSPECIFIED TOLERANCES	
www.alpsr.com www.gdxjdz.com www.xbswitch.com					



DONG GUAN XI BANG ELECTRONIC CO., LTD

DSND		SCALE: N/A	MODEL TYPE: SIM CARD CONN
DWN		VIEW:	PART NO.: XKSMO-072-P9
CHKD		UNIT: mm/in	DWG NO.:
APPD		SIZE: A4	
		WEIGHT	SHEET
			1/1
		REVISION	A0